

PRODUCTION DATA SHEET

DESCRIPTION

The LX8820 is an ultra lowlinear regulator. voltage regulator has a precise, fixed

The LX8820 output is internally programmed for 3.3V.

ceramic, tantalum or electrolytic sizes. types. Capacitance range large values.

The CMOS wafer increasing regulator efficiency by minimizina operating around current (typically compared to BiPolar technology.

The low RDS_{ON} of the PMOS output dropout single output positive- stage results in ultra low dropout The (typically 0.45V @ 1A).

Output voltage overshoot output capable of delivering 1.2 controlled using slew rate control, as V_{IN} is applied, typically V_{OUT} overshoot < 2% for V_{IN} ≤ 1V/ μ S ramp. Transient response to a Step Load is fast and Regulator stability is maintained controlled, V_{OUT} overshoot remains with any capacitor ESR, allowing within 2% of nominal for 400mA step

Thermal Shutdown, Current Limit flexible beginning with 2.2µF to and Short Circuit Current protection are integrated on-chip for survival process during fault conditions.

> Microsemi's small 3x3mm body size (MO-229) package enables maximum <200µA). power dissipation with a minimum surface mount area.

KEY FEATURES

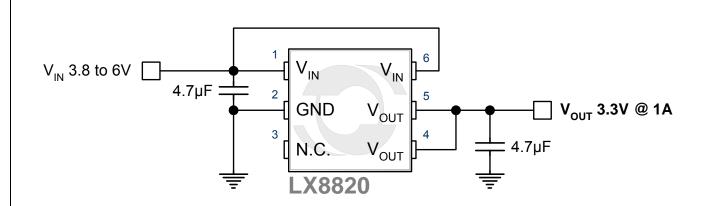
- Accurate Output Voltage
- Typical Dropout of 0.7V at 1A and 0.25V at 0.8A
- Independent Thermal and Current Limit Protection
- Low Tolerance Load Regulation
- Wide DC Supply Voltage of 4V to 10V
- Loop Stability Independent of **Output Capacitor Type**
- JEDEC MO-229 surface mount package / RoHS Compliant

APPLICATIONS/BENEFITS

- 5V to 3.3V Regulators
- Hard Disk Drives, CD-ROMs
- ADSL and Cable Modems
- **Battery Charging Circuits**
- Instrumentation
- PC Peripherals

IMPORTANT: For the most current data, consult MICROSEMI's website: http://www.microsemi.com

APPLICATION CIRCUITS



•	PACKAGE ORDER INFO				
	T _J (°C)	OUTPUT V	Plastic MLP 6- PIN RoHS Compliant / Pb-free	Part Marking	
	0 to 125	3.3V	LX8820-33CLM	882J or 8820	

Note: Available in Tape & Reel. Append the letters "TR" to the part number. (i.e. LX8820-33CLM-TR)



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ABSOLUTE MAXIMUM RATINGS

Input Voltage (V _{IN})	10V
Load Current (Internally Limited)	
Power Dissipation	
Short-Circuit Protection	Indefinite
Operating Junction Temperature	150°C
Storage Temperature Range	65°C to 150°C
RoHS / Pb-free Peak Package Solder Reflow Temperature	
(40 second maximum exposure)	260°C (+0,-5)

eNote: Exceeding these ratings could cause damage to the device. All voltages are with respect to Ground. Currents are positive into, negative out of specified terminal.

THERMAL DATA

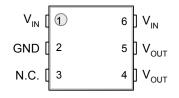
LM Plastic MLP 6-Pin

THERMAL RESISTANCE-JUNCTION TO TAB, θ_{JT}	8°C/W
THERMAL RESISTANCE-JUNCTION TO AMBIENT, θ_{JA}	29-35°C/W
(Typical, depending on mounting/pcb layout)	29-33 C/VV

Junction Temperature Calculation: $T_J = T_A + (P_D x \theta_{JA})$.

The θ_{JA} numbers are guidelines for the thermal performance of the device/pc-board system. All of the above assume no ambient airflow. θ_{JA} can vary significantly depending on mounting technique. (See Application Notes Section: Thermal considerations)

PACKAGE PIN OUT



LM PACKAGE (Top View)

Heatsink must be connected to GND or left floating (see pg 7 for details)

N/C = Not internally connected, don't care for PCB layout consideration.

RoHS / Pb-free 100% Matte Tin Lead Finish

FUNCTIONAL PIN DESCRIPTION						
PIN NAME	DESCRIPTION					
V _{IN}	Positive unregulated supply input for the regulator. Bypass to GND with at least 2.2µF of low ESR and ESL capacitance.					
GND	Common terminal for ground reference. The input and output bypass capacitors should be connected to this pin.					
V _{OUT}	Regulator output. It is recommended to bypass to GND with at least 2.2µF. Size your output capacitor to meet the transient loading requirement. If you have a very dynamic load, a lower ESR capacitor will improve the response to these load steps.					

RECOMMENDED MAX OPERATING CONDITIONS

Parameter	Symbol	LX8820-33			Units
Falanietei	Symbol	Min	Тур	Max	Ullits
Input Voltage	V _{IN}	4.5		10	V
Load Current (with adequate heat sinking)	IL			1200	mA



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ELECTRICAL CHARACTERISTICS

Unless otherwise specified, the following specifications apply over the operating ambient temperature $0^{\circ}C \le T_A \le 125^{\circ}C$ except where otherwise noted and the following test conditions: $V_{IN} = 5V$, $I_{OUT} = 10 \text{mA}$, $C_1 = 4.7 \mu \text{F}$ (ceramic), $C_2 = 4.7 \mu \text{F}$ (ceramic), & $T_J = T_A$ using low duty cycling methods.

Parameter	Symbol	Symbol Test Conditions	L	LX8820-33			
Parameter	Syllibol	rest Conditions	Min	Тур	Max	Units	
Fixed Output (3.3V)							
Output Voltage	V _{OUT}	5mA < I _{OUT} < 1A, 4.75V < V _{IN} < 5.25V	3.234	3.300	3.366	V	
Line Regulation	$\Delta V_{OUT}(V_{IN})$	4.5V < V _{IN} < 5.5V, 5mA < I _{OUT} < 1A		4	9	mV	
e Load Regulation	$\Delta V_{OUT}(I_{OUT})$	10mA < I _{OUT} < 1A, V _{IN} = 4.75V		2	15	mV	
Dropout Voltage	V_{DO}	$I_{LOAD} = 1A, \ \Delta V_{OUT} = -1\%$		0.45		V	
	V DO	I _{LOAD} = 1A, V _{IN} = 4.0V	3.0	3.3	3.383		
Transient Response; V _{OUT} Overshoot at Start-Up	V _{OUT}	V_{IN} step 0V to 5V; $t_r \ge 1 \mu s$; 10mA < I_{OUT} < 1A Note 2			3.63	V	
Transient Response; V _{OUT} Droop to Step Load	V _{OUT}	$V_{IN} = 5V; t_r \ge 1\mu s; 10mA < I_{OUT} < 1A$ Note 2	3.0			٧	
Current Limit	I _{OUT (MAX)}	V _{IN} < 5.5V	1.0	1.5		Α	
Minimum Load Current	ΙL	Note 1		0	0.1	mA	
Quiagant Current	IQ	I _{OUT} =5mA		205	300		
Quiescent Current		I _{OUT} =1000mA, V _{IN} < 7V		550	650	μA	
Ripple Rejection	PSRR	f=120Hz, V _{IN} = 5V	50	75		dB	
RMS Output Noise (% of V _{OUT})	V _{OUT (RMS)}	10Hz < f < 10kHz		0.003		%/V	
Thermal Shutdown	T_{JSD}		140	160		°C	

- Note 1: Minimum load current is defined as the amount of output current required to maintain regulation.
- Note 2: Guaranteed by design.

BLOCK DIAGRAM

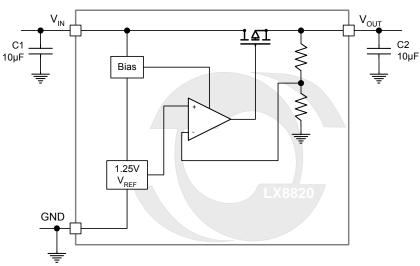
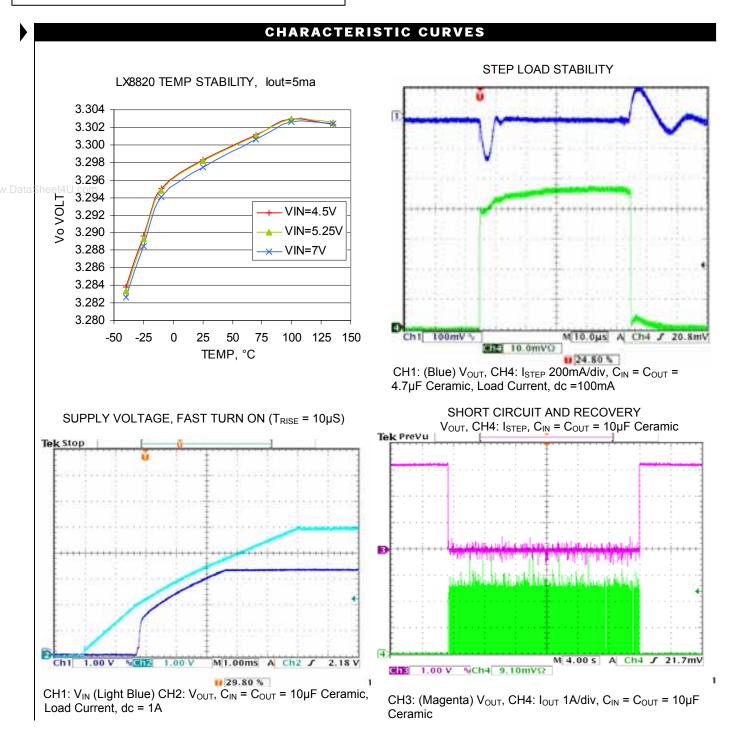


Figure 1 – Fixed Output Note: Application Circuit above using ceramic capacitors



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APPLICATION INFORMATION

Description

The LX8820 is part of a family of LDO (Low Drop-Out) linear regulators in the JEDEC MO-229 package that offer maximum power dissipation in a low profile surface mount technology. The LX8820 output is fixed at 3.3V output and can supply up to one amp with a regulator design optimized for system efficiency by consuming minimal ground current and directing quiescent current to the load.

Input Capacitor

To improve load transient response and noise rejection an input bypass capacitor of at least $2.2\mu F$ is required. Generally we recommend a $4.7\mu F$ ceramic or tantalum or $22\mu F$ electrolytic capacitor.

Output Capacitor

The regulator requires an output capacitor connected between $V_{\rm OUT}$ to GND to stabilize the internal control loop. Many types of capacitors are available, with different capacitance values tolerances, temperature coefficients and equivalent series resistance. We recommend a minimum of $4.7\mu F$. To ensure good transient response from the power supply system under rapidly changing current load conditions, designers generally use additional output capacitors connected in parallel. Such an arrangement serves to minimize the effects of the parasitic resistance (ESR) and inductance (ESL) that are present in all capacitors. The regulator has been tested stable with capacitor ESR's in the range of 0.01 to 2 ohms. We have found it best to use the same type of capacitor for both input and output bypass.

Minimum Load Requirement

The LX8820 has a minimum load requirement for proper output regulation specified at 0.1mA.

Temperature Protection

The thermal protection shuts the LX8820 down when the junction temperature exceeds 140°C. Exposure to absolute maximum rated conditions for extended periods may affect device reliability (see Thermal Considerations below).

Current Limit Protection

The LX8820 includes over current protection. When the output load current exceeds typically 1.5A, the circuit forces the regulator output to decrease.

Thermal Considerations

Thermal shutdown protects the integrated circuit from thermal overload caused from a rise in junction temperature during power dissipation. This means of protection is intended for fault protection only and not as a means of current or power limiting during normal application usage. Proper thermal evaluation should be done to ensure that the junction temperature dose not exceed it's maximum rating. Operating at the maximum $T_{\rm J}$ of $150^{\circ}{\rm C}$ can impact reliability . Due to variation in individual device electrical characteristics and thermal resistance , the built in thermal overload protection may be activated at power levels slightly above or below the rated dissipation. Also peak output power should be considered for each individual output.

Power dissipation for the regulator can be calculated using the following equation:

$$P_D = (V_{IN(MAX)} - V_{OUT}) \cdot I_{OUT}$$

(Note: power dissipation resulting from quiescent (ground) current is negligible)

Junction temperature of the integrated circuit can be calculated using:

$$T_{\text{JUNCTION}} = T_{\text{JUNCTION-TABRISE}} + T_{\text{TAB-AMBRISE}} + T_{\text{AMB}}$$

$$T_{TAB} = P_{DMAX} \cdot \Theta_{JT}$$

$$T_{TAB-AMB} = P_{DREG} \cdot \Theta_{PCB}$$

An example: Given conditions: $T_A = 70$ °C, $V_{IN} = 5.0$ V, $V_{out} = 3.3$ V, $I_{out} = 200$ mA.

Calculated values:

$$T_{J-TABREG} = (5V - 3.3V) \cdot (200mA) \cdot 8^{\circ}C/W$$

$$T_{TAB-AMB\,RISE} = (340mW) \cdot 32^{\circ}C/W = 10.9^{\circ}C$$

$$T_{\text{JUNCTION}} = 2.7^{\circ}\text{C} + 10.9^{\circ}\text{C} + 70^{\circ}\text{C} = 83.6^{\circ}\text{C}$$

It is important to note that although each output of the regulator will produce up to 1.5A in current, the total power dissipation may limit the useful total current draw. The junction temperature should be calculated to insure the maximum junction temperature is not exceeded.

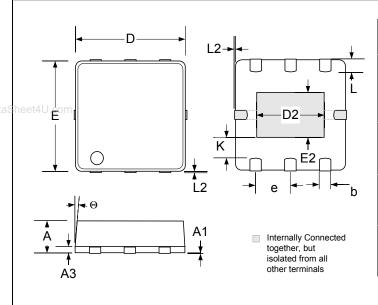


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MECHANICAL DRAWINGS

JEDEC – MO229

6-Pin Plastic Micro Lead Package



Dim	MILLIMETERS		INCHES		
Dilli	MIN	MAX	MIN	MAX	
Α	0.80	1.00	0.032	0.040	
A1	0.00	0.05	0	0.002	
A3	0.20 REF		0.008 REF		
b	0.30	0.45	0.012	0.018	
D	2.90	3.10	0.114	0.122	
Е	2.90	3.10	0.114	0.122	
е	0.95 E	3SC	0.037	BSC	
D2	1.90	2.25	0.075	0.086	
E2	1.15	1.65	0.045	0.065	
K	0.20	-	0.008	-	
L	0.30	0.45	0.012	0.018	
L2	-	0.10	-	0.004	
Θ	0°	12°	0°	12°	

NOTES

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